mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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X42182

Z-Power series is designed for high current operation and high flux output applications.



Z-Power LED's thermal management perform exceeds other power LED solutions. It incorporates state of the art SMD design and Thermal emission material.

Z Power LED is ideal light sources for general illumination applications, custom designed solutions, automotive large LCD backlights

X42182

Features

- Super high flux output and high luminance
- Designed for high current operation
- Low thermal resistance
- SMT solderability
- Lead free product
- RoHS compliant

Applications

- Mobile phone flash
- Automotive interior / Exterior lighting
- Automotive signal lighting
- Automotive forward lighting
- Torch
- Architectural lighting
- LCD TV / Monitor backlight
- Projector light source
- Traffic signals
- Task lighting
- Decorative / Pathway lighting
- Remote / Solar powered lighting
- Household appliances

*The appearance and specifications of the product may be changed for improvement without notice.

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Full Code of Z-Power LED Series

Full code form : $X_1 X_2 X_3 X_4 X_5 X_6 - X_7 X_8 - X_9 X_{10} X_{11} X_{12} X_{13}$

1. Part Number

- X₁ : Color
- X₂: Z-Power LED series number
- X₃ : LENS type
- X₄: Chip quantity (or Power Dissipation)
- X₅: Package outline size
- X₆ : Type of PCB

2. Internal Number

- X₇
- X₈

3. Code Labeling

- X₉: Luminous flux (or Radiant flux for royal blue)
- X₁₀ X₁₁ X₁₂ : Dominant wavelength (or x,y coordinates rank code)
- X_{13} : Forward voltage

4. Sticker Diagram on Reel & Aluminum Vinyl Bag



For more information about binning and labeling, refer to the Application Note -1

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Outline Dimension

1. Dome Type



Bottom view







Notes :

- 1. All dimensions are in millimeters. (tolerance : ± 0.2)
- Scale : none
 Slug of package is connected to anode.

*The appearance and specifications of the product may be changed for improvement without notice.



Outline Dimension

2. PCB Type



Star Type

Notes :

- 1. All dimensions are in millimeters. (tolerance : ± 0.2)
- 2. Scale : none
- *The appearance and specifications of the product may be changed for improvement without notice.

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Characteristics for Z-Power LED

1. Pure White (W42182)

1-1 Electro-Optical characteristics at I_F =350mA, T_A =25°C

Parameter		Symbol		Unit		
			Min	Тур	Max	Unit
Luminous Flux ^[1]	T rank	Φ _V [2]	70	80	91	lm
	U rank	Φ _V [2]	91	100	-	lm
Correlated Color Temperature [3]		ССТ	-	6300	-	K
CRI		R _a	-	70	-	-
Forward Voltage [4]		V _F	2.9	3.25	4	V
View Angle		20 1⁄2	120			deg.
Thermal resistance [5]		Rθ _{J-B}	8.5			°C/W
Thermal resistance	[6]	Rθ _{J-C}		6.9		°C/W

1-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	т	1000 (@ Tj = 90 °C) ^[7]	mΔ
Forward Current	τ _F	1800 (@ 1KHz, 1/10 duty)	ША
Power Dissipation	P _d	4	W
Junction Temperature	Tj	145(@ I _F ≤700mA)	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [8]	-	$\pm 10,000$ V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_{V} is the total luminous flux output as measured with an integrated sphere.

[3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT $\pm 5\%$

[4] A tolerance of $\pm 0.06V$ on forward voltage measurements

[5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_J \leq 110$ °C) $R\theta_{J-C}$ is measured with only emitter. (25 °C $\leq T_J \leq 110$ °C)

Break voltage of Metal PCB is 6.5kVAC.

[7] I_F Max is guaranteed under the T_J ≤90 °C.

[8] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink.

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Characteristics for Z-Power LED

2. Warm White (N42182)

2-1 Electro-Optical characteristics at I_F =350mA, T_A =25°C

Parameter	Symbol		Unit		
Falanielei	Symbol	Min	Тур	Max	Unit
Luminous Flux [1]	Φ _V [2]	-	53	-	lm
Correlated Color Temperature [3]	ССТ	-	3000	-	K
CRI	R _a	-	93	-	-
Forward Voltage [4]	V _F	2.9	3.25	4	V
View Angle	20 1/2	124		deg.	
Thermal resistance [5]	Rθ _{J-B}	8.5		°C/W	
Thermal resistance [6]	Rθ _{J-C}		6.9		°C/W

2-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I_{F}	800	mA
Power Dissipation	P _d	3.2	W
Junction Temperature	Τ _j	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	-	$\pm 10,000$ V HBM	-

*Notes :

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT $\pm 5\%$ tester tolerance
- [4] A tolerance of $\pm 0.06V$ on forward voltage measurements
- [5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C \leq T_J \leq 110 °C) R θ_{J-C} is measured with only emitter. .(25 °C \leq T_J \leq 110 °C) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

-----Caution-----Caution 1. Please do not drive at rated current more than 5 sec. without proper heat sink

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Characteristics for Z-Power LED

3. Natural White (S42182)

3-1 Electro-Optical characteristics at $I_F=350$ mA, $I_A=25^{\circ}$	3-1	Electro-Optical	characteristics	at $I_F = 350 \text{mA}$,	T₄=25°C
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Parameter	Symbol		Unit		
Faianletei	Symbol	Min	Тур	Max	Unit
Luminous Flux ^[1]	Φ _V [2]	-	61	-	lm
Correlated Color Temperature [3]	ССТ	-	4000	-	K
CRI	R _a	-	93	-	-
Forward Voltage [4]	V_{F}	2.9	3.25	4	V
View Angle	20 1/2	124		deg.	
Thermal resistance [5]	Rθ _{J-B}	8.5		°C /W	
Thermal resistance [6]	Rθ _{J-C}		6.9		°C /W

3-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	Ι _F	800	mA
Power Dissipation	P _d	3.2	W
Junction Temperature	Tj	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [8]	-	$\pm 10,000$ V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_{V} is the total luminous flux output as measured with an integrated sphere.

[3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT $\pm 5\%$

[4] A tolerance of $\pm 0.06V$ on forward voltage measurements

 $\begin{array}{l} [5], \ [6] \ \mathsf{R}\theta_{J\text{-}B} \text{ is measured with a SSC metal core pcb.} (25\ ^\circ\text{C} \leq T_J \leq 110\ ^\circ\text{C}) \\ & \mathsf{R}\theta_{J\text{-}C} \text{ is measured with only emitter.} \ (25\ ^\circ\text{C} \leq T_J \leq 110\ ^\circ\text{C}) \\ & \mathsf{Break voltage of Metal PCB is } 6.5 \text{kVAC.} \end{array}$

 $\left[7\right]$ It is included the zener chip to protect the product from ESD.

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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Characteristics for Z-Power LED

4. Blue (B42182)

4-1 Electro-Optical characteristics at I_F =350mA, T_A =25°C

Davamatar	Symbol		Unit		
Parameter		Min	Тур	Max	Unit
Luminous Flux ^[1]	Φ _V [2]	-	22	-	lm
Dominant Wavelength ^[3]	λ_{D}	455	465	475	nm
Forward Voltage [4]	V _F	2.9	3.25	4	V
View Angle	20 1/2	130		deg.	
Thermal resistance [5]	Rθ _{J-B}	8.5		°C /W	
Thermal resistance [6]	Rθ _{J-C}		6.9		°C /W

4-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	1000	mA
Power Dissipation	P _d	4	W
Junction Temperature	Τ _j	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	-	\pm 10,000V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_V is the total luminous flux output as measured with an integrated sphere.

 $\left[3\right]$ Dominant wavelength is derived from the CIE 1931 Chromaticity diagram.

A tolerance of ± 0.5 nm for dominant wavelength

[4] A tolerance of $\pm 0.06V$ on forward voltage measurements

[5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_J \leq 110$ °C) R θ_{J-C} is measured with only emitter. .(25 °C $\leq T_J \leq 110$ °C) Break voltage of Metal PCB is 6.5kVAC

[7] It is included the zener chip to protect the product from ESD.

-----Caution----

1. Please do not drive at rated current more than 5 sec. without proper heat sink 2. Blue power light sources represented here are IEC825 Class 2 for eye safety

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Characteristics for Z-Power LED

5. Royal Blue (D42182)

5-1 Electro-Optical characteristics at I_F =350mA, T_A =25°C

Davamatav	Symbol		Unit		
Parameter		Min	Тур	Max	Unit
Radiant Power ^[1]	Φ _V ^[2]	-	468	-	mW
Dominant Wavelength [3]	λ_{D}	455	457	460	nm
Forward Voltage [4]	V _F	2.9	3.25	3.8	V
View Angle	20 1/2	130		deg.	
Thermal resistance [5]	Rθ _{J-B}	8.5		°C/W	
Thermal resistance [6]	Rθ _{J-C}		6.9		°C/W

5-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	1000	mA
Power Dissipation	P _d	4	W
Junction Temperature	Τ _j	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	-	±10,000V HBM	-

*Notes :

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrated sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. CCT $\pm 5\%$ tester tolerance
- [4] A tolerance of $\pm 0.06V$ on forward voltage measurements
- [5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_{J} \leq 110$ °C) R θ_{J-C} is measured with only emitter. .(25 °C $\leq T_{J} \leq 110$ °C) Break voltage of Metal PCB is 6.5kVAC
- [7] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sink 2. Blue power light sources represented here are IEC825 Class 2 for eye safety

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Characteristics for Z-Power LED

6. Green (G42182)

Parameter	Symbol	Value			Unit
	Symbol	Min	Min Typ Max	Unit	
Luminous Flux ^[1]	Φ _V [2]	-	70	-	lm
Dominant Wavelength ^[3]	λ_{D}	520	525	535	nm
Forward Voltage [4]	V _F	2.9	3.25	4	V
View Angle	20 1/2		130		deg.
Thermal resistance [5]	Rθ _{J-B}	9.5			°C /W
Thermal resistance [6]	Rθ _{J-C}		8.0		°C /W

6-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	1000	mA
Power Dissipation	P _d	4	W
Junction Temperature	Τ _j	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	_	$\pm 10,000$ V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_V is the total luminous flux output as measured with an integrated sphere.

[3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram.

A tolerance of ± 0.5 nm for dominant wavelength

[4] A tolerance of $\pm 0.06V$ on forward voltage measurements

[5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_J \leq 110$ °C) $R\theta_{J-C}$ is measured with only emitter. .(25 °C $\leq T_J \leq 110$ °C) Break voltage of Metal PCB is 6.5kVAC

[7] It is included the zener chip to protect the product from ESD.

-----Caution-----

1. Please do not drive at rated current more than 5 sec. without proper heat sin

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Characteristics for Z-Power LED

7. Red (R42182)

Parameter	Symbol	Value			Unit
	Symbol	Min	Min Typ	Max	Unit
Luminous Flux ^[1]	Φ _V [2]	-	48	-	lm
Dominant Wavelength ^[3]	λ_D	618	625	630	nm
Forward Voltage [4]	V _F	2.0	2.3	3.0	V
View Angle	20 1/2	130			deg.
Thermal resistance [5]	Rθ _{J-B}	9			°C /W
Thermal resistance [6]	Rθ _{J-C}	7.8			°C /W

7-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	Ι _F	800	mA
Power Dissipation	P _d	2.4	W
Junction Temperature	Tj	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	-	\pm 10,000V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_{V} is the total luminous flux output as measured with an integrated sphere.

[3] Dominant wavelength is derived from the CIE 1931 Chromaticity diagram.

- A tolerance of ± 0.5 nm for dominant wavelength
- [4] A tolerance of $\pm 0.06V$ on forward voltage measurements

[5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_J \leq 110$ °C) $R\theta_{J-C}$ is measured with only emitter. .(25 °C $\leq T_J \leq 110$ °C) Break voltage of Metal PCB is 6.5kVAC

[7] It is included the zener chip to protect the product from ESD.

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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Characteristics for Z-Power LED

8. Amber (A42182)

Parameter	Symbol		Unit		
	Symbol	Min	Тур	Max	Unit
Luminous Flux [1]	Φ _V [2]	-	48	-	lm
Dominant Wavelength ^[3]	λ_{D}	585	590	595	nm
Forward Voltage [4]	V_{F}	2.0	2.3	3.0	V
View Angle	20 1/2		130		deg.
Thermal resistance [5]	Rθ _{J-B}	9			°C /W
Thermal resistance [6]	Rθ _{J-C}	7.8		°C /W	

8-2 Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	Ι _F	800	mA
Power Dissipation	P _d	2.4	W
Junction Temperature	Τ _j	145	٥C
Operating Temperature	T _{opr}	-40 ~ +85	٥C
Storage Temperature	T _{stg}	-40 ~ +100	٥C
ESD Sensitivity [7]	-	\pm 10,000V HBM	-

*Notes :

[1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.

[2] Φ_{V} is the total luminous flux output as measured with an integrated sphere.

 $\left[3\right]$ Dominant wavelength is derived from the CIE 1931 Chromaticity diagram.

A tolerance of ± 0.5 nm for dominant wavelength

[4] A tolerance of $\pm 0.06V$ on forward voltage measurements

[5], [6] $R\theta_{J-B}$ is measured with a SSC metal core pcb.(25 °C $\leq T_J \leq 110$ °C) $R\theta_{J-C}$ is measured with only emitter. .(25 °C $\leq T_J \leq 110$ °C) Break voltage of Metal PCB is 6.5kVAC

[7] It is included the zener chip to protect the product from ESD.

1. Please do not drive at rated current more than 5 sec. without proper heat sink

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Color Spectrum, T_A=25°C

1. Pure White



2. Warm White



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Color Spectrum, T_A=25°C

3. Natural White



4. Red, Amber, Green, Blue(Royal Blue)





Junction Temperature Characteristics







Junction Temperature Characteristics

2. Forward Voltage Shift vs. Junction Temperature at $I_{\rm F}{=}350\text{mA}$



3. Wavelength Shift vs Junction Temperature at I_F =350mA





Forward Current Characteristics

1. Forward Voltage vs. Forward Current , $T_A{=}25\ ^{o}c$



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Forward Current Characteristics

2. Forward Current vs. Normalized Relative Luminous Flux, T_A =25 °c





Forward Current Characteristics

3. Forward Current vs Wavelength Shift, T_A=25 °c



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Ambient Temperature vs Allowable Forward Current

1-1. Pure White, Warm White, Natural White, Green, Blue(Royal Blue) (T_{JMAX} = 145 °C, @350mA)



1-2. Pure White, Warm White, Natural White, Green, Blue(Royal Blue) (T_JMAX = 145 °C, @700mA)



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Ambient Temperature vs Allowable Forward Current





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Ambient Temperature vs Allowable Forward Current





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2. Warm White, Natural White



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Recommended Solder pad

1. Solder pad







<Rear view>

2. Solder paste pattern



Note :

1. All dimensions are in millimeters (tolerance : ± 0.2)

2. Scale none

*The appearance and specifications of the product may be changed for improvement without notice.

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